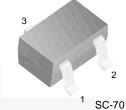


June 2013

# FJX3906 PNP Epitaxial Silicon Transistor

## **Feature**

• General-Purpose Transistor



1. Base 2. Emitter 3. Collector

## **Ordering Information**

Part Number	Top Mark	Package	Packing Method
FJX3906TF	S2A	SC70 3L	Tape and Reel

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}$ C unless otherwise noted.

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	-40	V
$V_{CES}$	Collector-Emitter Voltage	40	V
$V_{EBO}$	Emitter-Base Voltage -5		V
I <sub>C</sub>	Collector Current	-200	mA
P <sub>C</sub>	Collector Power Dissipation	350	mW
T <sub>STG</sub>	Storage Temperature	-55 to +150	°C

## Thermal Characteristics(1)

Symbol	Parameter	Value	Unit
P <sub>D</sub>	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Air	357	°C/W

1

### Note:

1. PCB size: FR-4 76 x 114 x 0.6 T mm<sup>3</sup> (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

## **Electrical Characteristics**(2)

Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = -10  \mu A, I_E = 0$	-40		V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C = -1.0 \text{ mA}, I_B = 0$	-40		V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	-5		V
I <sub>CEX</sub>	Collector Cut-Off Current	$V_{CE} = -30 \text{ V}, V_{EB} = -3 \text{ V}$		-50	nA
		$V_{CE} = -1 \text{ V, } I_{C} = -0.1 \text{ mA}$	60		
•		$V_{CE} = -1 \text{ V, } I_{C} = -1 \text{ mA}$	80		
h <sub>FE</sub> DC Current	DC Current Gain	$V_{CE} = -1 \text{ V}, I_{C} = -10 \text{ mA}$	100	300	
		$V_{CE} = -1 \text{ V}, I_{C} = -50 \text{ mA}$	60		
		$V_{CE} = -1 \text{ V}, I_{C} = -100 \text{ mA}$	30		
\/ (oot)	Collector-Emitter Saturation Voltage	$I_C = -10 \text{ mA}, I_B = -1 \text{ mA}$		-0.25	V
V <sub>CE</sub> (sat)		$I_C = -50 \text{ mA}, I_B = -5 \text{ mA}$		-0.40	V
V <sub>BE</sub> (sat) Base-	Page Emitter Seturation Voltage	$I_C = -10 \text{ mA}, I_B = -1 \text{ mA}$	-0.65	-0.85	V
	Base-Emitter Saturation Voltage	$I_C = -50 \text{ mA}, I_B = -5 \text{ mA}$		-0.95	V
C <sub>ob</sub>	Output Capacitance	$V_{CB} = -5 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$	(	4.5	pF
f <sub>T</sub>	Current Gain Bandwidth Product	$V_{CE} = -20 \text{ V}, I_{C} = -10 \text{ mA}$	250		MHz
NF	Noise Figure	$I_C$ = -10 μA, $V_{CE}$ = -5 V, $R_S$ = 1 kΩ, $f$ = 10 Hz to 15.7 kHz		4	dB
t <sub>ON</sub>	Turn-On Time	$V_{CC} = -3 \text{ V}, V_{BE} = -0.5 \text{ V},$ $I_{C} = -10 \text{ mA}, I_{B1} = -1 \text{ mA}$		70	ns
t <sub>OFF</sub>	Turn-Off Time	$V_{CC} = -3 \text{ V}, I_{C} = -10 \text{ mA},$ $I_{B1} = I_{B2} = 1 \text{ mA}$		300	ns

## Note:

2. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2.0%.

## **Typical Performance Characteristics**

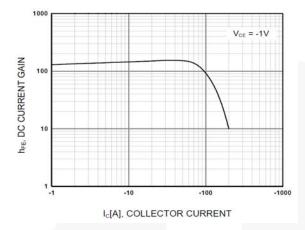


Figure 1. DC Current Gain

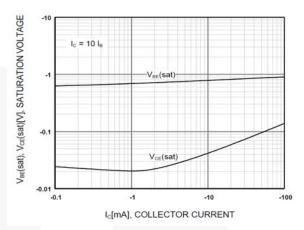


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

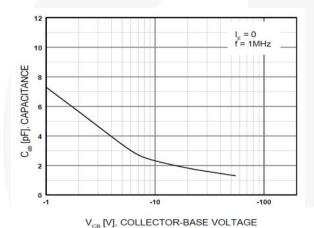


Figure 3. Output Capacitance

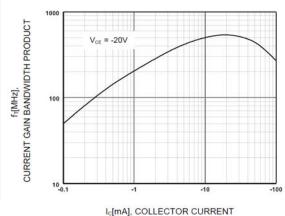


Figure 4. Current Gain Bandwidth Product

## **Physical Dimensions**

## SC-70 (SOT-323)

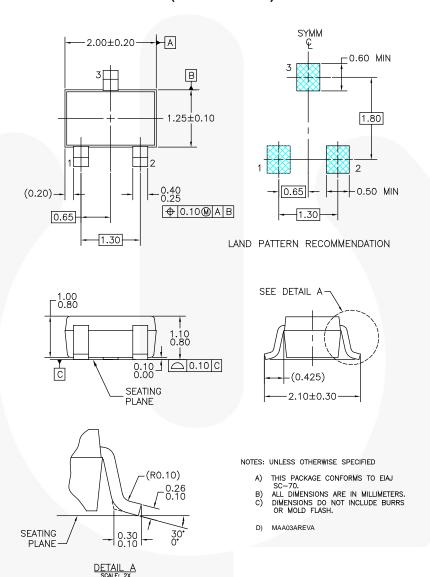


Figure 5. 3-LEAD, SC90, EIAJ SC-70, 1.25 MM WIDE (ACTIVE)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <a href="http://www.fairchildsemi.com/packaging/">http://www.fairchildsemi.com/packaging/</a>.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: <a href="http://www.fairchildsemi.com/packaging/tr/sc703">http://www.fairchildsemi.com/packaging/tr/sc703</a> tr.pdf.





#### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

FPS™ AccuPower™ F-PFS™ AX-CAP®, FRFET® BitSiC™ Global Power Resource<sup>SM</sup> GreenBridge™ Build it Now™ CorePLUS™ Green FPS™

CorePOWER™ Green FPS™ e-Series™ Gmax™ CROSSVOLT™

 $\mathsf{CTL}^\mathsf{TM}$ GTO™ Current Transfer Logic™ IntelliMAX™ ISOPLANAR™ **DEUXPEED®** 

Making Small Speakers Sound Louder Dual Cool™

EcoSPARK® and Better™ EfficientMax™ MegaBuck™  $\mathsf{ESBC}^{\mathsf{TM}}$ MICROCOUPLER™ ■® MicroFET™ MicroPak™ Fairchild®

MicroPak2™ Fairchild Semiconductor® MillerDrive™ FACT Quiet Series™ MotionMax™ FACT' mWSaver™ FAST® OptoHiT™ FastvCore™ OPTOLOGIC® FETBench™ OPTOPLANAR® PowerTrench® PowerXS™

Programmable Active Droop™

OFET' QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM® STEAL TH™ SuperFET SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™

SYSTEM GENERAL®\*

TinyBoost™ TinyBuck™ TinyCalc™ TinyLogic<sup>®</sup> TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC™ TriFault Detect™ TRUECURRENT®\* uSerDes™

UHC Ultra FRFET™ UniFFT™ **VCX™** VisualMax™ VoltagePlus™

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## **ANTI-COUNTERFEITING POLICY**

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com,

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors

#### PRODUCT STATUS DEFINITIONS

#### Definition of Terms

duct Status ive / In Design	Definition  Datasheet contains the design specifications for product development. Specifications may change
ive / In Design	
	in any manner without notice.
Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
n Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
	Production

Rev. 164

<sup>\*</sup> Trademarks of System General Corporation, used under license by Fairchild Semiconductor.